

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **Reversible Attachment of a Membrane Active Polymer to a Polynucleotide**, filed **February 17, 2004** as U.S. Patent Application **10/780,484**.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

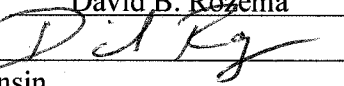
I hereby appoint the following attorney(s) and/or agents, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

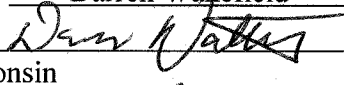
Kirk Ekena, Registration Number 56672
George W. Johnston, Registration Number 28090
Dennis P. Tramaloni, Registration Number 28542
Patricia S. Rocha-Tramaloni, Registration Number 31054
Samuel H. Megerditchian, Registration Number 45678
John P. Parise, Registration Number 34403
Brian C. Remy, Registration Number 48176
Kimberly J. Prior, Registration Number 41483
David E. Wildman, Registration Number 40226
Gene J. Yao, Registration Number 47193

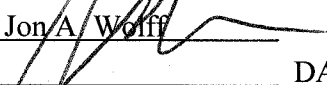
Address all telephone calls to: Kirk Ekena
608.238.4400

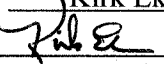
All correspondence to: Roche Madison Inc.
Attn: Kirk Ekena
505 South Rosa Road
Madison, WI 53719

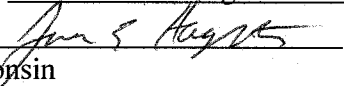
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF INVENTOR: David B. Rozema
INVENTOR'S SIGNATURE  DATE 10/27/08
RESIDENCE: Madison, Wisconsin
Citizenship: US Post Office Address: 5731 Pembroke Drive, Madison, WI 53711

FULL NAME OF INVENTOR: Darren Wakefield
INVENTOR'S SIGNATURE  DATE 10/28/08
RESIDENCE: Fitchburg, Wisconsin
Citizenship: US Post Office Address: 2790 Lyman Lane, Fitchburg, WI 53711

FULL NAME OF INVENTOR: Jon A. Wolff
INVENTOR'S SIGNATURE  DATE _____
RESIDENCE: Fitchburg, Wisconsin
Citizenship: US Post Office Address: 1122 University Bay Drive, Madison, WI 53705

FULL NAME OF INVENTOR: Kirk Ekena
INVENTOR'S SIGNATURE  DATE 10/27/08
RESIDENCE: Fitchburg, Wisconsin
Citizenship: US Post Office Address: 5711 Richardson Cir., Fitchburg, WI 53711

FULL NAME OF INVENTOR: James E. Hagstrom
INVENTOR'S SIGNATURE  DATE 10/27/08
RESIDENCE: Fitchburg, Wisconsin
Citizenship: US Post Office Address: 4700 Bergamot Way, Middleton, WI 53562